

PTO-1449 INFORMATION DISCLOSURE  STATEMENT BY APPLICANT  LIST OF ITEMS		ATTORNEY DOCKET NO. 13DV-12817				SERIAL NO.			
		APPLICANT(s) - Thomas C. Mesing et al.							
		FILING DATE				GROUP			

  

U.S. PATENT DOCUMENTS														
EXAMINER INITIAL		DOCUMENT NUMBER								DATE	NAME	CLASS	SUB-CLASS	FILING DATE IF APPROPRIATE
		3	8	5	6	2	4	4						
<i>Bjm</i>	AA	3	8	5	6	2	4	4	12/1974	Menshen	248	68	7/1972	
	AB	3	9	8	2	3	0	4	9/1976	Menshen	24	73	12/1974	
	AC	4	2	0	2	0	9	0	5/1980	Cook	29	417	3/1978	
	AD	4	2	7	3	4	6	5	6/1981	Schoen	403	391	8/1979	
	AE	4	3	9	3	9	9	8	7/1983	Allen et al.	248	74	7/1981	
	AF	4	8	9	9	9	6	9	2/1990	Bauer et al.	248	161	12/1988	
	AG	4	9	7	1	2	6	8	11/1990	Dobrowski et al.	244	135	11/1988	
	AH	5	0	3	3	7	0	1	7/1991	Kraus	248	68.1	1/1990	
	AI	5	2	3	4	1	8	5	8/1993	Hoffman et al.	248	56	2/1992	
	AJ	5	2	7	1	5	8	8	12/1993	Doyle	248	68.1	7/1992	
	AK	5	6	1	5	8	5	2	4/1997	Heidorn et al.	248	74.5	4/1995	
	AL	5	7	6	9	5	5	6	6/1998	Colley	403	24	12/1996	
	AM	5	7	9	4	8	9	7	8/1998	Jobin et al.	248	74.4	4/1996	
	AN	5	8	2	0	0	4	8	10/1998	Shereyk et al.	248	68.1	4/1996	
	AO	5	8	8	7	8	3	2	3/1999	Elvegaard	248	68.1	11/1996	
<input checked="" type="checkbox"/>	AP	5	8	9	0	6	8	4	4/1999	Stewart et al.	248	68.1	3/1997	
<i>Bjm</i>	AQ	5	9	4	1	4	8	3	8/1999	Baginski	248	68.1	4/1998	

  

FOREIGN PATENT DOCUMENT																
		DOCUMENT NUMBER								DATE	COUNTRY	CLASS	SUB-CLASS	TRANSLATION		
		YES	NO													
	AR															

  

OTHER INFORMATION (Including Author, Title, Pertinent Pages, Etc.)		
<i>Bjm</i>	AS	Article entitled: Low-Cost Resin Transfer Molding Process Developed for High-Temperature Polyimide Matrix Composites - <a href="http://www.lerc.nasa.gov/WWW/RT1995/5000/5150v.htm">http://www.lerc.nasa.gov/WWW/RT1995/5000/5150v.htm</a>

  

EXAMINER <i>B.J. Messer</i>	DATE CONSIDERED <i>9/28/04</i>
-----------------------------	--------------------------------

  

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.